



Click [here](#) for the 3D model.

| Dimensions | |
|------------|------------------|
| Chip Size | 1206 |
| L | 3.3mm +/-0.4mm |
| W | 1.6mm +/-0.35mm |
| T | 0.78mm +/-0.20mm |
| B | 0.6mm +/-0.25mm |

| Packaging Specifications | |
|--------------------------|--------------------------|
| Packaging | T&R, 180mm, Plastic Tape |
| Packaging Quantity | 4000 |

| General Information | |
|---------------------|----------------------------------|
| Series | SMD Auto X7R VW80808 |
| Style | SMD Chip |
| Description | SMD, MLCC, Automotive Grade |
| Features | VW 80808 Specification Compliant |
| RoHS | Yes |
| Termination | Flexible Termination |
| Failure Rate | N/A |
| Qualifications | AEC-Q200 |
| AEC-Q200 | Yes |
| Shelf Life | 152 Weeks |

| Specifications | |
|--|-----------------------|
| Capacitance | 0.1 uF |
| Capacitance Tolerance | 10% |
| Voltage DC | 50 VDC |
| Dielectric Withstanding Voltage | 125 VDC |
| Temperature Range | -55/+125°C |
| Temperature Coefficient | X7R |
| Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC) | 15%, 1kHz 1.0Vrms |
| Dissipation Factor | 2.5% 1 kHz 1.0Vrms |
| Insulation Resistance | 10 GOhms |